



Material Content Data Sheet



Halogen-Free

Sales Product Name IPD60R3K3C6

Issued

11. April 2021

MA# MA005342314

Package PG-TO252-3-341

Weight*

387.15 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.000	0.26	0.26	2582	2582
leadframe	inorganic material	phosphorus	7723-14-0	0.069	0.02		178	
	non noble metal	iron	7439-89-6	0.229	0.06		592	
	non noble metal	copper	7440-50-8	228.946	59.14	59.22	591370	592140
wire	non noble metal	aluminium	7429-90-5	0.429	0.11	0.11	1109	1109
encapsulation	organic material	carbon black	1333-86-4	0.395	0.10		1020	
	plastics	epoxy resin	-	11.975	3.09		30932	
	inorganic material	silicondioxide	60676-86-0	119.224	30.80	33.99	307957	339909
leadfinish	non noble metal	tin	7440-31-5	3.740	0.97	0.97	9661	9661
plating	non noble metal	nickel	7440-02-0	0.509	0.13	0.13	1314	1314
solder	non noble metal	tin	7440-31-5	0.029	0.01		74	
	noble metal	silver	7440-22-4	0.036	0.01		92	
	non noble metal	lead	7439-92-1	1.363	0.35	0.37	3519	3685
heatspreader	inorganic material	phosphorus	7723-14-0	0.006			15	
	non noble metal	iron	7439-89-6	0.019			50	
	non noble metal	copper	7440-50-8	19.177	4.95	4.95	49535	49600
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com